## ORIGINAL RESEARCH



# Electrodeposited Cu-Sn Alloy for Electrochemical CO<sub>2</sub> Reduction to CO/HCOO<sup>-</sup>

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Published online: 1 November 2017

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**Abstract** Cu-Sn alloy electrodes were prepared by simple electrodeposition method for the electrochemical reduction of CO<sub>2</sub> into CO and HCOO-. The alloy electrode surfaces provided good selectivity and efficiency in electrochemical CO<sub>2</sub> conversion because they provided appropriate binding energies between the metal and the reactive species obtained through CO<sub>2</sub> reduction. Therefore, product selectivity can be modulated by altering the Cu-Sn crystal structure of the electrode. Using the Cu-Sn alloy electrodes, electrochemical reduction was performed at applied potentials ranging from -0.69 to -1.09 V vs. reversible hydrogen electrode (RHE). During electrochemical CO<sub>2</sub> reduction, all the prepared Cu-Sn alloy electrodes showed prominent suppression of hydrogen evolution. In contrast, Cu<sub>87</sub>Sn<sub>13</sub> has high selectivity for CO formation at all the applied potentials, with maximum faradaic efficiency (FE) of 60% for CO at - 0.99 V vs. RHE. On the other hand, Cu<sub>55</sub>Sn<sub>45</sub> obtained a similar selectivity for electrodeposition of Sn, with FE of 90% at - 1.09 V vs. RHE. Surface characterization results showed that the crystal structure of Cu<sub>87</sub>Sn<sub>13</sub> comprised solid solutions that play an important role in increasing the selectivity for CO formation. Additionally, it suggests that the selectivity for HCOO

formation is affected by the surface oxidation state of Sn rather than by crystal structures like intermetallic compounds.

**Keywords**  $CO_2$  reduction  $\cdot CO_2$  conversion  $\cdot Cu$ -Sn alloy  $\cdot$  Product selectivity  $\cdot$  Carbon monoxide  $\cdot$  Formic acid

#### Introduction

Greenhouse gases have recently garnered great attention from the viewpoint of global warming and climate change. Since CO<sub>2</sub> gas is a greenhouse gas, CO<sub>2</sub> reduction is required to address the global issue of increasing CO<sub>2</sub> emission [1]. To this end, many researchers have undertaken CO<sub>2</sub> reduction and conversion to energetic compounds by chemical, biological, photochemical, inorganic, and electrochemical approaches [2–4]. Among these approaches, the electrochemical reduction of water-dissolved CO<sub>2</sub> in the presence of a metal catalyst can generate CO, HCOO-, and hydrocarbons with high current efficiency and high reaction selectivity [5-7]. The products obtained from CO<sub>2</sub> depend on the metal species used as the catalyst. Cu as CO<sub>2</sub> reduction reaction (CO<sub>2</sub>RR) catalyst generates hydrocarbons including C<sub>1</sub>, C<sub>2</sub>, and C<sub>3</sub> products [7–9]. Au, Ag, Pd, and Zn catalysts provide high selectivity for CO production and HCOO is the major product obtained with Sn, Hg, and Pb catalysts [5, 6, 10]. In the presence of other metal catalysts, hydrogen evolution reaction (HER) occurs preferentially compared to CO<sub>2</sub>RR [5]. This product selectivity is due to the binding energy of CO<sub>2</sub> and its reaction intermediates to the metal species, as confirmed by density functional theory (DFT) studies [7, 10–12]. Binding energy was also affected by the crystal face and valence of



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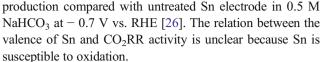
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metals such as Cu and Cu<sub>2</sub>O [13–16]. In other words, for highly efficient and selective  $CO_2RR$ , we need to design catalysts considering the binding energy of  $CO_2$  and it reaction intermediates to the catalyst surface.

CO<sub>2</sub>RR activity of Cu electrode has attracted attention over the year because it can produce hydrocarbons like methane, ethylene, methanol, and ethanol with a relatively high efficiency. In polycrystalline Cu, CO formation competes with HCOO formation at applied potentials less than – 0.9 V vs. reversible hydrogen electrode (RHE). Hydrocarbons formation starts at - 0.9 V and ethylene is formed first, followed by methane. At applied potentials more negative than -0.9 V, methane formation dominates over ethylene formation, and the formation of ethanol, methanol, and C<sub>3</sub> products starts. The HER competes directly with CO<sub>2</sub>RR but decreases with increasing applied potential [8, 9]. On the other hand, in Cu single-crystal electrode, product selectivity of CO<sub>2</sub>RR depends on the Cu crystal surface [13], suggesting that changes in deficiency of surface, step, and edge have a significant effect on product selectivity [9]. In addition, Cu<sub>2</sub>O possesses high selectivity for ethylene formation due to the significant inhibition of methane formation [15, 16]. At present, the factor responsible for changing  $C_1$  and  $C_2$  selectivity is not evident; however, the aforementioned results yield useful knowledge in terms of selectivity control.

DFT calculations have established that the selectivity of CO<sub>2</sub>RR is enhanced by using alloys [17–19]. Alloying controls the binding energy of the CO<sub>2</sub>RR reactive species to the electrode surface by changing the metal species and content ratio. Kortlever et al. reported that altering the composition of Pd and Pt in the  $Pd_xPt_{(100-x)}/C$  catalyst led to a major change in HCOO selectivity [20]. Among Cu-based alloy catalysts, oxide-derived Cu<sub>x</sub>Zn prepared by electroplating possesses high selectivity for ethanol formation with faradaic efficiency (FE) of  $\sim 30\%$ , as reported by Ren et al. [21]. Meanwhile, CuInO<sub>2</sub> prepared by electrophoretic deposition showed increased CO selectivity compared to Cu<sub>2</sub>O [22]. Moreover, Cu-Sn catalyst achieved CO production FE of ~ 90% by changing the deposition amount of Sn on oxide-derived Cu surface. This results in suppressed H<sub>2</sub> and HCOO<sup>-</sup> formation, as confirmed by DFT calculations [23]. However, the cause for increasing selectivity due to the formation of Cu-Sn alloy is not clear. The dependence of selectivity on alloy composition was also not clarified.

When CO<sub>2</sub>RR was performed on commercial Sn electrode, FE of HCOO<sup>-</sup> production was over 91% in 0.1 M KHCO<sub>3</sub> at – 1.8 V vs. Ag/AgCl [24]. Moreover, for Sn electroplated on Cu plate, FE of HCOO<sup>-</sup> varied with Sn electrodeposition thickness and it was 91% at – 1.4 V vs. SCE [25]. As mentioned earlier, Sn has high selectivity toward HCOO<sup>-</sup>. This phenomenon suggested that the surface oxide of Sn plays an important role in HCOO<sup>-</sup> formation. It has been reported that Sn etched with HBr showed significantly low FE for HCOO<sup>-</sup>



In this study, we focused on an electrode coated with electrodeposited Cu-Sn alloy for CO<sub>2</sub> electroreduction catalysts. There are many reports on co-deposition of two metal catalysts to improve selectivity, but we control reaction products from the standpoint of alloy structures like solid solutions or intermetallic compounds. Specifically, we proposed to control product selectivity of CO and HCOO by changing the crystal structure and alloy composition ratio of Cu and Sn, respectively. The Cu-Sn alloy electrode was prepared using an electroplating method and the composition ratio was adjusted by altering the molar ratio of the Cu-Sn electrolyte. Surface characteristics of the Cu-Sn catalysts were analyzed using scanning electron microscopy (SEM), X-ray diffraction (XRD), X-ray photoelectron spectroscopy (XPS), and auger electron spectroscopy (AES). Our study shows that the Cu-Sn alloy can control product selectivities of CO and HCOO by altering the alloy composition. The effect of alloy composition on the selectivity for CO<sub>2</sub>RR was also discussed.

# **Experimental**

### **Electrodeposition of Cu-Sn Alloy**

The Cu-Sn alloy catalysts were prepared by the electrodeposition method. All the prepared catalyst electrodes used Cu plate (T=0.2 mm, Nillaco Corp.) as the substrate. The Cu plate was washed three times by ultrasound in acetone and then was similarly rinsed with ultrapure water. It was then immersed in 1 M HCl for 30 s and dried by N<sub>2</sub> followed by rinsing with ultrapure water before use as the working electrode (WE). The electrolyte consisted of 0.5 M K<sub>4</sub>P<sub>2</sub>O<sub>7</sub> (97%, Sigma-Aldrich Co. LLC), 0.05 M C<sub>6</sub>H<sub>14</sub>N<sub>2</sub>O<sub>7</sub> (99.0%, Sigma-Aldrich Co. LLC), and varying concentrations of CuSO<sub>4</sub>·5H<sub>2</sub>O (99.5%, Wako Ltd.) and SnSO<sub>4</sub> (96%, Wako Ltd.), such that the total concentration of metals was 0.2 M dissolved in ultrapure water. The electrodeposition on the Cu substrate was carried out using a two-electrode system where the counter electrode (CE) was a Pt plate. To study the effect of Cu-Sn alloy catalysts on CO<sub>2</sub> reduction activity, we employed Cu and Sn electrodeposited electrodes. The electrolyte for Cu electrodeposition comprised 0.5 M K<sub>4</sub>P<sub>2</sub>O<sub>7</sub>, 0.2 M C<sub>4</sub>H<sub>12</sub>N<sub>2</sub>O<sub>5</sub> (99.0%, Sigma-Aldrich Co. LLC), and 0.2 M CuSO<sub>4</sub>·5H<sub>2</sub>O dissolved in ultrapure water. The Sn electrodeposition electrolyte comprised 0.5 M K<sub>4</sub>P<sub>2</sub>O<sub>7</sub>, 0.2 M SnSO<sub>4</sub>, 1 g/L PEG 6000 (Wako Ltd.), and 0.6 mL/L formalin. The prepared catalysts were washed with ultrapure water and dried N<sub>2</sub>. The electrodeposition conditions for various Cu-Sn alloys, Cu, and Sn on Cu substrate are shown in Table 1.



**Table 1** Electrodeposition condition of various catalysts. The composition ratio of each Cu-Sn alloy was decided by AES analysis

	Cu	$Cu_{87}Sn_{13} \\$	$Cu_{76}Sn_{24}$	Cu <sub>55</sub> Sn <sub>45</sub>	Sn
$K_4P_2O_7(M)$	0.5	0.5	0.5	0.5	0.5
$C_6H_{14}N_2O_7(M)$		0.05	0.05	0.05	
$C_4H_{12}N_2O_5(M)$	0.2				
CuSO <sub>4</sub> ·5H <sub>2</sub> O (M)	0.2	0.18	0.16	0.1	
SnSO <sub>4</sub> (M)		0.02	0.04	0.1	0.2
PEG 6000 (g/L)					1
Formalin (mL/L)					0.6
Current density (mA/cm <sup>2</sup> )	5.6	3.2	3.2	3.6	1
Deposition time (min)	5	5	5	5	5

# **Characterization of Prepared Catalysts**

To determine the composition ratio of the prepared Cu-Sn catalysts before and after CO2 electroreduction, they were analyzed by AES (JEOL Ltd., JAMP-7810). The X-ray source used an LaB<sub>6</sub> filament. The surface morphology of the prepared catalysts was analyzed before and after CO<sub>2</sub> reduction using SEM (JEOL Ltd., JSM-6701). The crystal face and structure of the Cu-Sn alloy was evaluated before and after CO<sub>2</sub> reduction by thin-film XRD (MAC Science, MO3XHF22) technique. The X-ray source used Cu Kα  $(\lambda = 0.154 \text{ nm}, 30 \text{ mA})$  and the scan angle recorded at  $2\theta$ value between 25° and 80° in steps of 0.2°. The chemical bonding states of Cu 2p and Sn 3d were analyzed before and after CO2 reduction by XPS (Shimadzu Co., KRATOS AXIS-NOVA) with Al K $\alpha$  as the X-ray source. The obtained binding energies of Cu 2p and Sn 3d orbitals were calibrated with the C-C bond of carbon contamination as a reference at 284.2 eV.

# Electrochemical Reduction of CO<sub>2</sub>

A custom-made two-compartment electrolysis cell made from acrylic plastic was used (Fig. 1). The Pt plate and Ag/AgCl (3.3 M KCl) were used as the CE and reference electrode (RE), respectively. The cathode was separated from the anode by a cation-exchange membrane (Nafion NRE-212, Sigma-Aldrich Co. LLC). The electrolyte (23 mL) used was 0.1 M KHCO<sub>3</sub> (99.5%, Wako Ltd.) solution saturated with CO<sub>2</sub> gas (99.995%, JFP) for 40 min. The CO<sub>2</sub> gas flowed continuously during the CO<sub>2</sub> electroreduction at a flow rate of 5 mL/min. The electrolyte was stirred by a stirring bar.

In the electrochemical measurements, the potential and current were controlled or measured using a potentiostat (Hokuto Denko Corp., HZ-7000) and the IR drop was corrected. In this study, the Ag/AgCl was converted to a reversible hydrogen electrode (RHE) at all potentials using the following formula:  $E_{RHE} = E_{Ag/AgCl} + 0.210 + (0.0591 \times pH). \label{eq:energy}$  Here, the pH of CO<sub>2</sub>-saturated 0.1 M KHCO<sub>3</sub> solution was 6.8. The

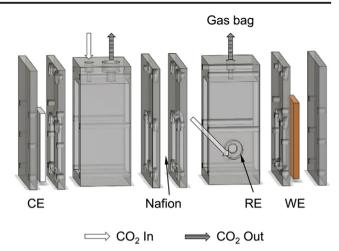


Fig. 1 Schematic of the electrolysis cell used for CO<sub>2</sub> reduction. WE, working electrode; RE, reference electrode; CE, counter electrode

electrochemical  $CO_2$  reduction was performed using controlled potential chronoamperometry for 1800 s and the applied potential was in the range from -0.69 to -1.09 V vs. RHE. The FE of the products from  $CO_2$  reduction was calculated based on Eq. (1).

$$FE = \frac{znF}{Q} \times 100 \tag{1}$$

Where, z is the number of electron transfers needed for  $CO_2$  reduction, n is the number of moles from the results of the quantitative analyses, F is the Faraday constant (96,485 C/mol), and O is the amount of electricity.

The gaseous products formed by CO<sub>2</sub> electroreduction and the introduced CO<sub>2</sub> gas were collected by a connected gas bag (Smart Bag PA, GL Sciences Inc.) and the head space of the electrolysis cell. The collected gas was analyzed by gas chromatography (GC, Shimadzu Co., Tracera). We used Micropacked ST (Shinwa Chemical Industries Ltd.) as the GC column and He (Iwatani Corp.) used as the carrier gas. The HCOO<sup>-</sup> content in the liquid products obtained after CO<sub>2</sub> reduction was analyzed by anion chromatography (IC, Shimadzu Co., Prominence HIC-SP) after dilution with ultrapure water. The column employed for IC was Shim-pack IC-SA3 (Shimadzu Co.) and the eluting solution was 3.6 mM Na<sub>2</sub>CO<sub>3</sub> (99.5%, Wako Ltd.) solution. The prepared electrodes were used for electrochemical CO<sub>2</sub> reduction just once. In this study, the FE of gaseous and liquid products was the mean amount of time spent on the CO2 reduction. Additionally, FE of the products was obtained by averaging the results of the experiments three times with CO<sub>2</sub> reduction on each electrode.

#### **Electrochemical Impedance Spectroscopy**

The electrochemical impedance spectroscopy (EIS) was carried out under the same conditions as those used for CO<sub>2</sub>.



electroreduction condition at -0.89 and -1.09~V vs. RHE in  $0.1~M~KHCO_3$  solution employed by the potentiostat. Before applying the AC amplitude potential, the cathode was kept at -0.89~or-1.09~V for 120~s to become stabilized to the current through the sample. The AC amplitude potential and measurement potential were set at 100~mV and -0.89~or-1.09~V, respectively, and the measurement frequency was scanned in a range of 100~kHz to 500~mHz.

#### **Results and Discussion**

## Characterization of Cu-Sn Alloy Catalysts

The composition ratio of Cu and Sn in the prepared Cu-Sn catalysts was determined before and after CO<sub>2</sub> reduction using AES measurement (Table 2). In this paper, the prepared Cu-Sn catalysts are described as Cu<sub>87</sub>Sn<sub>13</sub>, Cu<sub>76</sub>Sn<sub>24</sub>, and Cu<sub>55</sub>Sn<sub>45</sub>, based on AES results. The Cu and Sn deposited electrodes are described as Cu<sub>100</sub> and Sn<sub>100</sub>, respectively. AES Cu signal on the Sn<sub>100</sub> electrode originated from the Cu substrate or diffusion of the Cu to deposited Sn [27, 28]. Any detected element apart from Cu and Sn was considered contamination from ambient air or oxide on the metal surface. Table 2 shows that the relative composition ratio of oxygen increased with increasing ratio of Sn due to Sn being more susceptible to oxidation than Cu. After CO<sub>2</sub> reduction at – 0.89 V vs. RHE for 30 min, the Cu-Sn ratio of the Cu-Sn catalysts slightly increased due to diffusion of Cu and Sn upon applying the reduction potential, as suggested by the SEM and XRD results after  $CO_2$  reduction [27, 28].

Figure 2a–j shows the SEM images of electrodeposited Cu and Sn on the Cu substrate.  $Cu_{100}$  and  $Sn_{100}$  comprise distributed particles with size of  $\sim 300$  nm. The Cu-Sn catalysts, except  $Cu_{55}Sn_{45}$ , have uniformly dense structures and particle size decreased with increasing Cu concentration.  $Cu_{55}Sn_{45}$ 

was complicated. After CO<sub>2</sub> reduction at – 0.89 V vs. RHE for 30 min, the macroscale morphologies of all the catalysts remained unchanged. The Cu<sub>100</sub> revealed particle abrasion, but particle size did not change before and after CO<sub>2</sub> reduction. On the other hand, Sn<sub>100</sub> exhibited cohesion and spalling of particles throughout the surface. Correspondingly, Cu<sub>55</sub>Sn<sub>45</sub> and Cu<sub>87</sub>Sn<sub>13</sub> were examined for deposition of small particles on the catalyst surface.

The crystalline structures of the Cu-Sn catalysts deposited

showed a unique surface morphology and crystal growth

on Cu plate were analyzed by XRD before and after CO<sub>2</sub> reduction (Fig. 3). All the catalysts exhibiting Cu diffraction peak originated from the substrate. Figure 3a shows that the main orientations of polycrystalline Cu<sub>100</sub> and Sn<sub>100</sub> exhibited Cu (111) and Sn (200), respectively. The Cu-Sn alloys show peaks that are different from those shown by elemental Cu or Sn [29–32]. For the Cu<sub>87</sub>Sn<sub>13</sub>, Cu and Sn formed solid solutions, inducing an increase in lattice spacing compared with Cu (111). The Cu<sub>76</sub>Sn<sub>24</sub> catalyst exhibited crystalline structures of both solid solutions and intermetallic compounds, which was identified as Cu<sub>3</sub>Sn. Meanwhile, Cu<sub>55</sub>Sn<sub>45</sub> comprised Cu<sub>3</sub>Sn and SnO<sub>2</sub> [33, 34]. After CO<sub>2</sub> reduction at - 0.89 V vs. RHE for 30 min, Cu-Sn alloy catalysts showed changes in X-ray diffraction peaks. These structural changes are attributed to the diffusion of Cu and Sn upon the application of a potential [27, 28].

The chemical bonding states of Cu 2p and Sn 3d in the alloys were analyzed by XPS before and after  $\rm CO_2$  reduction (Fig. 4). The chemical state of Cu on  $\rm Cu_{100}$  and the Cu-Sn alloy catalysts was CuO (934 eV). For  $\rm Sn_{100}$ , the Cu 2p peak is attributed to the substrate and the diffusion of Cu to Sn; this is similar to the AES result. For Sn 3d,  $\rm Cu_{87}Sn_{13}$  and  $\rm Cu_{76}Sn_{24}$  showed the same oxidation state (485.6 eV), consisting of a high percentage of SnO. On the other hand, the Sn 3d peaks of  $\rm Cu_{55}Sn_{45}$  and  $\rm Sn_{100}$  shifted to high binding energy (486.0 eV), consisting of higher percentages of  $\rm SnO_2$  than in  $\rm Cu_{87}Sn_{13}$  and

**Table 2** Relative composition ratios on the surfaces of the prepared catalysts, as per AES measurements

	Relative composition ratio (%)									
	Cu	Sn	С	О	Si	K	P	N	S	
Sn <sub>100</sub>	2.2	30.0	4.4	42.5	_	18.5	2.4	_	_	
$Sn_{100}$ - $AR^a$	5.8	44.4	10.7	39.1	_	_	_	_	_	
$Cu_{55}Sn_{45}$	25.2	20.8	14.1	37.4	2.5	_	_	_	_	55
$Cu_{55}Sn_{45}$ - $AR^a$	29.2	21.8	13.0	34.0	2.0	_	_	_	_	57
$Cu_{76}Sn_{24}$	41.3	12.9	14.6	31.2	_	_	_	_	_	76
$Cu_{76}Sn_{24}$ - $AR^a$	43.7	10.0	19.6	26.7	_	_	_	_	_	81
$Cu_{87}Sn_{13}$	50.3	7.3	15.0	27.4		_	_	_	_	87
$Cu_{87}Sn_{13}$ - $AR^a$	48.0	6.1	21.4	24.5		_	_	_	_	89
$Cu_{100}$	49.8	_	22.6	21.1	_	_	_	4.9	1.6	
Cu <sub>100</sub> -AR <sup>a</sup>	44.9	_	25.8	18.2	_	_	_	10.1	1.1	

<sup>&</sup>lt;sup>a</sup> After CO<sub>2</sub> reduction in 0.1 M KHCO<sub>3</sub> at – 0.89 V vs. RHE



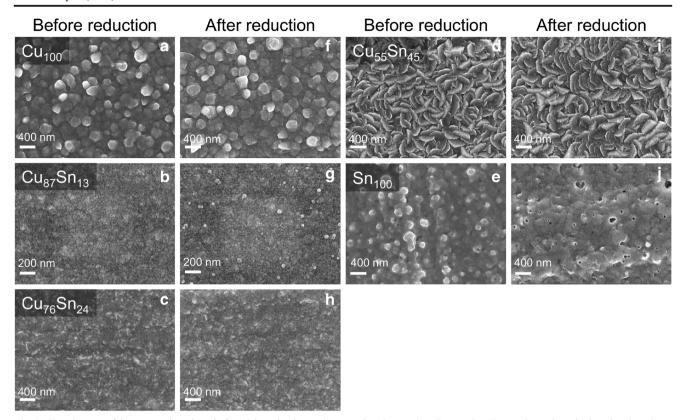


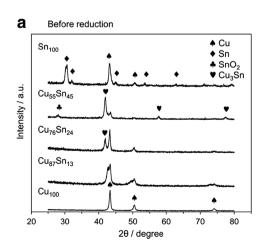
Fig. 2 SEM images of the prepared catalysts before CO<sub>2</sub> reduction: a  $Cu_{100}$ ; b  $Cu_{87}Sn_{13}$ ; c  $Cu_{76}Sn_{24}$ ; d  $Cu_{55}Sn_{45}$ ; e  $Sn_{100}$  deposited on Cu plate. SEM images of the prepared catalysts after CO<sub>2</sub> reduction: f  $Cu_{100}$ ; g  $Cu_{87}Sn_{13}$ ; h  $Cu_{76}Sn_{24}$ ; i  $Cu_{55}Sn_{45}$ ; j  $Sn_{100}$  deposited on Cu plate

Cu<sub>76</sub>Sn<sub>24</sub> [35, 36]. Hence, the difference in the oxidation state of Sn might affect the selectivity for CO<sub>2</sub>RR. Apart from Cu<sub>100</sub>, the other samples showed very little difference in the Sn 3d and Cu 2p spectra before and after CO<sub>2</sub> reduction at – 0.89 V vs. RHE for 30 min. The Cu state in Cu<sub>100</sub> became Cu<sup>0</sup> and CuO upon reduction from the Cu<sub>2</sub>O state during CO<sub>2</sub> reduction. These results clearly suggest that the changes in morphology and crystal structure were not affected by the chemical bonding states of Cu and Sn.

## CO<sub>2</sub> Reduction on Cu-Sn Alloy Catalysts

The  $CO_2$  electroreduction on the prepared catalysts was conducted in a custom-made electrolysis cell (Fig. 1) for 1800 s at applied potentials ranging from -0.69 to -1.09 V vs. RHE. The FE values for products by  $CO_2$  electroreduction are shown in Fig. 5. The product distribution obtained with the Cu deposition catalyst was similar to that for a reported Cu electrode and distinct from an oxide-derived Cu electrode

Fig. 3 XRD patterns of the prepared catalysts before  $CO_2$  reduction. a XRD patterns of the prepared catalysts after  $CO_2$  reduction in 0.1 M KHCO<sub>3</sub> at - 0.89 V vs. RHE. b Crystal structures of  $Cu_{87}Sn_{13}$  were identified as solid solutions.  $Cu_{76}Sn_{24}$  consists of  $Cu_3Sn$  as intermetallic compounds and solid solutions. For  $Cu_{55}Sn_{45}$ ,  $Cu_3Sn$  and  $SnO_2$  were identified as components



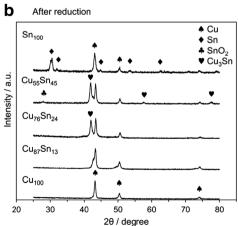
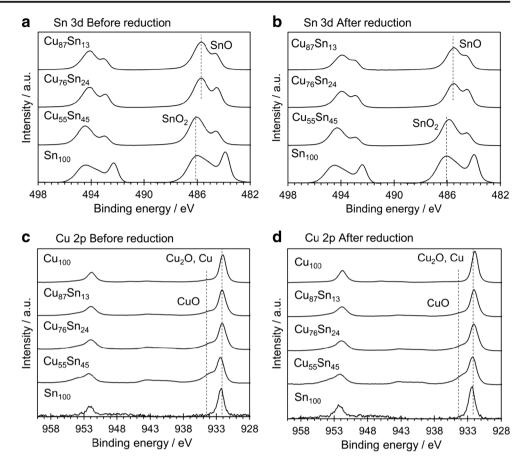




Fig. 4 XPS spectra. a Sn 3d spectra of  $Cu_{87}Sn_{13}$ ,  $Cu_{76}Sn_{24}$ ,  $Cu_{55}Sn_{45}$ , and Sn before reduction. b Sn 3d spectra after reduction. c Cu 2p spectra  $Cu_{100}$ ,  $Cu_{87}Sn_{13}$ ,  $Cu_{76}Sn_{24}$ ,  $Cu_{55}Sn_{45}$ , and Sn before reduction. d Cu 2p spectra after reduction. The broken line indicates the position of each chemical bonding state:  $SnO_2$ , SnO, CuO,  $Cu_2O$ , and Cu



(Fig. 5a) [7, 8, 16, 37]. FE for  $\rm H_2$  decreased with increasing applied potential; production of  $\rm CH_4$  and  $\rm C_2H_4$  was confirmed at – 0.79 V vs. RHE and it showed FE of 36% at – 1.09 V. FE values for CO and HCOO $^-$  presented the same tendency, FE for HCOO $^-$  being higher than that for CO at all applied potentials. These results showed that the Cu electrodeposition electrode leads to poor selectivity toward CO and HCOO $^-$ . On the other hand, the Sn electrodeposition catalyst showed high FE for HCOO $^-$  (Fig. 5e), in agreement with other research on CO<sub>2</sub> electroreduction with Sn electrode [24, 25]. Sn<sub>100</sub> exhibited similar FE for  $\rm H_2$  and HCOO $^-$  at – 0.69 V; FE for  $\rm H_2$  decreased with increasing applied potential, while FE for HCOO $^-$  remarkably increased to 87.5% at – 1.09 V. As mentioned earlier, it is evident that the selectivity of CO production on the Sn<sub>100</sub> electrode is poor.

The prepared Cu-Sn alloy catalysts exhibited different selectivities for  $CO_2RR$ . All Cu-Sn alloys can suppress HER, suggesting that the presence of Sn within the alloy by binding strongly to the surface H [23]. In  $Cu_{87}Sn_{13}$ , the selectivity of CO production was increased and maximum FE for CO was 59.5% at – 0.99 V vs. RHE (Fig. 5b). However, the FE for CO did not change significantly with increasing applied potential.  $Cu_{87}Sn_{13}$  showed a decreasing trend for  $H_2$  generation with increasing potential. HCOO $^-$  production shows a trend opposite to that for  $H_2$  formation, and exhibited 12.3% FE at

- 1.09 V.  $\rm Cu_{87}Sn_{13}$  produced very little hydrocarbons compared to  $\rm Cu_{100}$ , and its maximum FE was 1.2% at - 1.09 V. From the differences in selectivity, it is clear that the crystal structure significantly affected the selectivity for  $\rm CO_2RR$ . More specifically, the formation of solid solutions affects the binding energy or binding pattern of  $\rm CO_2$  and its reaction intermediates. Additionally, when CO formed mainly, it may be suspected that the binding energy against surface CO (\*CO) gets lowered as compared to that of Cu. This decrease in binding energy is considered to depend on the lattice spacing of Cu (111) or changing surface electron density, or both.

The  $CO_2$  reduction behavior of  $Cu_{76}Sn_{24}$  was intermediate between those of  $Cu_{87}Sn_{13}$  and  $Cu_{55}Sn_{45}$  (Fig. 5c). From -0.69 to -0.89 V, the FE for the products showed trends similar to  $Cu_{87}Sn_{13}$ . At over -0.89 V,  $HCOO^-$  production increased dramatically, and it has nearly the same FE as that of CO at -1.09 V.  $H_2$  formation decreased with increasing applied potential, same as for other electrodes. These characteristics suggest that  $Cu_{76}Sn_{24}$ , which consists of  $Cu_3Sn$  and solid solutions, was present at different reactive sites for  $CO_2$  reduction on applying potential. At a low applied potential, the Cu site that originated in  $Cu_3Sn$  and solid solutions involved CO production. On the other hand, at a high applied potential,  $HCOO^-$  production occurring from the Sn site originated from  $Cu_3Sn$ . The FE for CO of  $Cu_{87}Sn_{13}$  and  $Cu_{76}Sn_{24}$  suggested



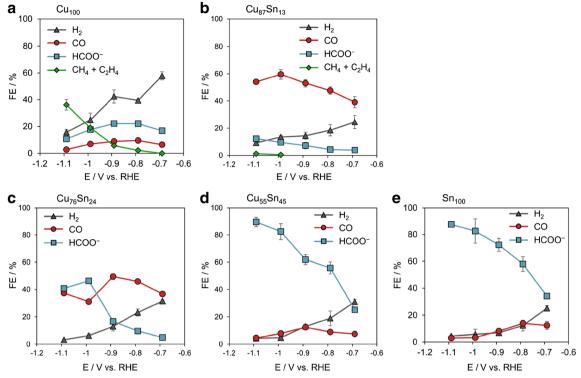


Fig. 5 Faradaic efficiency of CO<sub>2</sub> electroreduction products as a function of potential. **a** Cu<sub>100</sub>; **b** Cu<sub>87</sub>Sn<sub>13</sub>; **c** Cu<sub>76</sub>Sn<sub>24</sub>; **d** Cu<sub>55</sub>Sn<sub>45</sub>; **e** Sn<sub>100</sub> deposited on Cu plate. Electrolyte, 0.1 M KHCO<sub>3</sub>

that CO production was closely related to the Cu lattice spacing and electron density.

The product distribution using the  $Cu_{55}Sn_{45}$  alloy electrode was close to that obtained with the  $Sn_{100}$  electrode (Fig. 5d). This suggests that the  $Cu_3Sn$  structure has no effects on the selectivity for  $CO_2RR$ . Another possible factor affecting  $CO_2RR$  could be the chemical binding state of Sn within the alloys. The crystal structures of  $SnO_2$  and Sn were observed by XRD analysis of  $Cu_{55}Sn_{45}$  (Fig. 3). Additionally, the XPS results (Fig. 4) show that the binding energy of Sn 3d, attributed to  $SnO_x$ , was the same as that of  $Sn_{100}$ ; however, it was different from that of  $Cu_{87}Sn_{13}$  and  $Cu_{76}Sn_{24}$ . In fact, the FE for  $HCOO^-$  depends on the oxidation state of Sn [26]. From these results, it is believed that the oxidation state of Sn, rather than the crystal structure of alloy at  $Cu_{55}Sn_{45}$ , strongly affects the formation of  $HCOO^-$ .

Figure 6 shows the total current density and partial current density of  $H_2$ , CO, and  $HCOO^-$  during  $CO_2$  reduction against the applied potentials. The current density was calculated from the geometric surface area (2.75 cm²). The  $j_{CO}$  and  $j_{HCOO}^-$  values of each electrode showed the same trend as did the FE. We discuss the relationship between the selectivity, current density, and charge transfer resistance (CT resistance) in the following sections.

#### **EIS Measurements on Cu-Sn Alloy**

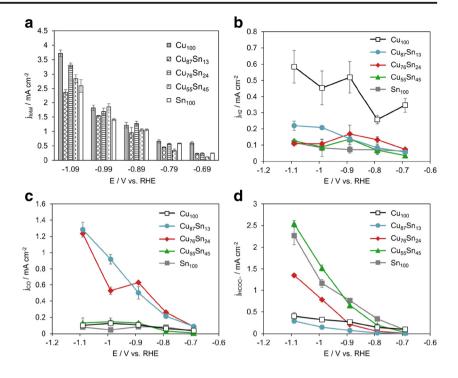
EIS measurements were performed under the same conditions as those for the  $CO_2RR$  at -0.89 and -1.09 V

vs. RHE; the obtained results were illustrated using the Cole-Cole plot. According to Fig. 7a and c, the low value in the x-axis indicates the solution resistance, and the diameter of the semicircle indicates the CT resistance (Fig. 7b, d). The CT resistance was found to be closely related to the current density; the catalysts with low CT resistance showed an increase in  $j_{\text{total}}$ , except for  $\text{Cu}_{100}$ .

Cu<sub>100</sub>exhibited high current density despite the large CT resistance, because it showed a high FE for multielectron reduction products, including CH<sub>4</sub> and C<sub>2</sub>H<sub>4</sub> (Fig. 5a). The CT resistance of Cu<sub>55</sub>Sn<sub>45</sub> and Sn<sub>100</sub>, which had a high  $j_{HCOO}$ , was lower than that of the other catalysts at - 0.89 and - 1.09 V. This suggested that the resistance of the reaction pathway for the generation of HCOO<sup>-</sup> from CO<sub>2</sub> was low; that is, CO<sub>2</sub>RR is not routed through the adsorption of CO<sub>2</sub> and its intermediates on Cu<sub>55</sub>Sn<sub>45</sub> and Sn<sub>100</sub>. At - 1.09 V, the CT resistance of Cu<sub>55</sub>Sn<sub>45</sub> was lower than that of Sn<sub>100</sub> and this result corresponded to the highest j<sub>HCOO</sub>. Cu<sub>76</sub>Sn<sub>24</sub> exhibited the same CT resistance as  $Sn_{100}$  at -0.89 and -1.09 V, but the  $j_{\text{total}}$ ,  $j_{\text{CO}}$ , and  $j_{\text{HCOO}}$  values were different from those of Sn<sub>100</sub>. This result suggests that the Sn sites originating from Cu<sub>3</sub>Sn possessed high selectivity for HCOO<sup>-</sup> and decreased CT resistance. The CT resistance of Cu<sub>87</sub>Sn<sub>13</sub> at both applied potentials was larger than that of the other Cu-Sn alloy, but the  $j_{total}$  value was smaller. Based on these results, we speculated that CO<sub>2</sub>RR on



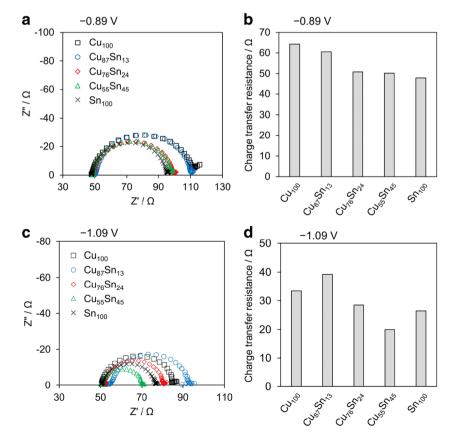
**Fig. 6** Total current density for CO<sub>2</sub> electroreduction as a function of potential on Cu<sub>100</sub>, Cu<sub>87</sub>Sn<sub>13</sub>, Cu<sub>76</sub>Sn<sub>24</sub>, Cu<sub>55</sub>Sn<sub>45</sub>, and Sn<sub>100</sub>. **a** Partial current density of the products from CO<sub>2</sub> reduction on each catalyst: **b** H<sub>2</sub>; **c** CO; **d** HCOO<sup>-</sup>



solid solutions progresses through the  $CO_2$  reaction intermediates binding to the catalyst surface.  $Cu_{87}Sn_{13}$  exhibited a larger CT resistance as compared to  $Cu_{76}Sn_{24}$  at

both potentials, probably because of the increase in the amount of adsorbed intermediates as compared to  $\text{Cu}_{87}\text{Sn}_{13}$ .

Fig. 7 Cole-Cole plot for  $Cu_{100}$ ,  $Cu_{87}Sn_{13}$ ,  $Cu_{76}Sn_{24}$ ,  $Cu_{55}Sn_{45}$ , and  $Sn_{100}$  during electrochemical  $CO_2$  reduction in 0.1 M KHCO<sub>3</sub> at  ${\bf a}=0.89$  and  ${\bf c}=1.09$  V vs. RHE. Charge transfer resistance of each electrode at  ${\bf b}=0.89$  and  ${\bf d}=1.09$  V vs. RHE





## CO<sub>2</sub>RR Mechanism for Each Cu-Sn Alloy

 ${\rm CO_2RR}$  mechanism on Cu surface has been elucidated employing DFT calculations [18, 38–40]. Briefly,  ${\rm CO_2}$  first adsorbs and reduces on Cu surface by accepting an electron and proton, and then forms surface HOCO (\*HOCO), which is adsorbed on the electrode. HCOO $^-$  is generated to desorb \*HOCO at this stage, and with the progression of the reduction reaction, adsorbed \*CO and  ${\rm H_2O}$  are generated. Similarly, CO is generated by the desorption of \*CO, and adsorbed surface HCO (\*HCO) is generated by the progress of the reduction reaction. Furthermore, with the progression of the reduction reaction, the \*HCO intermediate becomes reduced and generates  ${\rm CH_4}$  and  ${\rm CH_3OH}$ . Generation of  ${\rm C_2}$  compounds require dimer formation from intermediates like \*CO [18]. The prepared  ${\rm Cu_{100}}$  electrode is considered to perform according to the above mechanism.

 ${\rm CO_2RR}$  on  ${\rm Cu_{87}Sn_{13}}$  is suggested to behave the same as the adsorbed phase of  ${\rm Cu_{100}}$  by EIS (Fig. 7). However,  ${\rm Cu_{100}}$  and  ${\rm Cu_{87}Sn_{13}}$  have different selectivities for  ${\rm CO_2}$  reduction and the main product on  ${\rm Cu_{87}Sn_{13}}$  was CO, because  ${\rm Cu_{87}Sn_{13}}$  was a solid solution which consists of Cu and Sn. It seems that formation of solid solutions increases the lattice spacing of Cu (111) and changes surface electron density. This surface characteristic change might lower the binding energy of the reaction intermediate \*CO. Furthermore,  ${\rm Cu_{87}Sn_{13}}$  inhibits further \*CO reduction at - 1.09 V, thereby enhancing CO formation [7].

Meanwhile, the proposed reaction pathway for HCOO<sup>-</sup> formation on Sn involved a reaction with CO<sub>2</sub> to generate surface H (\*H) [38, 41]. In this study, the Sn<sub>100</sub> electrode might react according to the abovementioned pathway, because Sn<sub>100</sub> exhibits a lower CT resistance than Cu<sub>100</sub> (Fig. 7). Among the prepared alloy catalysts, Cu<sub>55</sub>Sn<sub>45</sub> follows the same mechanism because its CO<sub>2</sub>RR selectivity and EIS results are similar to those of Sn<sub>100</sub>. These results suggest that the active site of CO<sub>2</sub>RR is Sn, i.e., the surface oxidation state of Sn, rather than the crystal structure of Cu<sub>55</sub>Sn<sub>45</sub>, is the major factor contributing to CO<sub>2</sub>RR.

In contrast,  $Cu_{76}Sn_{24}$  exhibited a CT resistance similar to that of  $Sn_{100}$  and  $Cu_{55}Sn_{45}$ , but the selectivity for  $CO_2RR$  was different from theirs. Discussion on  $Cu_{76}Sn_{24}$  is difficult because the Cu and Sn sites in  $Cu_3Sn$  affect  $CO_2RR$  selectivity (Fig. 5c). The EIS results suggested that surface Sn affects the adsorbed state and the reaction pathway.

## Conclusion

We prepared Cu-Sn alloy catalytic electrodes through the simple electrodeposition method for electrochemical CO<sub>2</sub> reduction. The Cu-Sn alloy catalysts can control the selectivity for CO and HCOO<sup>-</sup> formation from CO<sub>2</sub> by changing the crystal

structure. In addition, these catalysts strongly inhibit HER compared to Cu due to the presence of Sn. Cu<sub>87</sub>Sn<sub>13</sub> showed high selectivity toward CO formation, such that its faradaic efficiency was 60% at -0.99 V vs. RHE differing from electrodeposited Cu catalysts. The surface analyses revealed that solid solutions play an important role in CO formation upon CO<sub>2</sub> reduction, because solid solution formation weakens the binding energy between the Cu-Sn alloy and the reaction intermediate \*CO. On the other hand, Cu<sub>55</sub>Sn<sub>45</sub> showed 89.5% of FE for HCOO at - 1.09 V; this result was nearly the same as that for  $Sn_{100}$  (87.5%). These results indicate that increasing surface SnO2 promotes HCOO rather than the presence of intermetallic compounds. The Cu<sub>76</sub>Sn<sub>24</sub> alloy exhibited properties intermediate between Cu<sub>87</sub>Sn<sub>13</sub> and Cu<sub>55</sub>Sn<sub>45</sub> at - 1.09 V, i.e., 37.4% FE for CO and 40.8% FE for HCOO<sup>-</sup>. This result suggested that there may be two active sites: Cu and Sn in Cu<sub>3</sub>Sn, due to which the selectivity behavior of CO<sub>2</sub>RR differs depending on applied potential.

**Acknowledgements** This research has been partly supported by the Advanced Catalytic Transformation Program for Carbon Utilization (ACT-C), Japan Science and Technology Agency (JST), and Research Center for Advanced Eco-Fitting Technology, Kyushu Institute of Technology.

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